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Details

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Product Status	Obsolete
Core Processor	S08
Core Size	8-Bit
Speed	40MHz
Connectivity	CANbus, I ² C, LINbus, SCI, SPI
Peripherals	LVD, POR, PWM, WDT
Number of I/O	39
Program Memory Size	96KB (96K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 16x12b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/pro/item?MUrl=&PartUrl=mc9s08dv96clf

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The following text should be added to the end of Section 16.4.2.3:

Writing to TPMxSC cancels any values written to TPMxMODH and/or TPMxMODL and resets the coherency mechanism for the modulo registers. Writing to TPMxCnSC cancels any values written to the channel value registers and resets the coherency mechanism for TPMxCnVH:TPMxCnVL.



Chapter 4 Memory

Table 4-3. High-Page Register Summary (Sheet 2 of 5)

Address	Register Name	Bit 7	6	5	4	3	2	1	Bit 0
0x181A	DBGCCX	RWCEN	RWC	PAGSEL	0	0	0	0	Bit 16
0x181B	DBGFX	PPACC	0	0	0	0	0	0	Bit 16
0x181C	DBGC	DBGEN	ARM	TAG	BRKEN	0	0	0	LOOP1
0x181D	DBGT	TRGSEL	BEGIN	0	0		TF	RG	
0x181E	DBGS	AF	BF	CF	0	0	0	0	ARMF
0x181F	DBGCNT	0	0	0	0		CN	NT	
0x1820	FCDIV	DIVLD	PRDIV8			D	V		
0x1821	FOPT	KEYEN	FNORED	EPGMOD	0	0	0	SE	C
0x1822	Reserved		_			_	_		_
0x1823	FCNFG	0	EPGSEL	KEYACC	1	0	0	0	1
0x1824	FPROT	EF	PS			FPS			FPOP
0x1825	FSTAT	FCBEF	FCCF	FPVIOL	FACCERR	0	FBLANK	0	0
0x1826	FCMD				FC	MD			
0x1827– 0x182F	Reserved	_	_	—	_	_	_	_	_
0x1830	SPI2C1	SPIE	SPE	SPTIE	MSTR	CPOL	CPHA	SSOE	LSBFE
0x1831	SPI2C2	0	0	0	MODFEN	BIDIROE	0	SPISWAI	SPC0
0x1832	SPI2BR	0	SPPR2	SPPR1	SPPR0	0	SPR2	SPR1	SPR0
0x1833	SPI2S	SPRF	0	SPTEF	MODF	0	0	0	0
0x1834	Reserved	0	0	0	0	0	0	0	0
0x1835	SPI2D	Bit 7	6	5	4	3	2	1	Bit 0
0x1836– 0x1837	Reserved	_	_	_	_	_	_	_	_
0x1838	PTKPE	PTKPE7	PTKPE6	PTKPE5	PTKPE4	PTKPE3	PTKPE2	PTKPE1	PTKPE0
0x1839	PTKSE	PTKSE7	PTKSE6	PTKSE5	PTKSE4	PTKSE3	PTKSE2	PTKSE1	PTKSE0
0x183A	PTKDS	PTKDS7	PTKDS6	PTKDS5	PTKDS4	PTKDS3	PTKDS2	PTKDS1	PTKDS0
0x183B	Reserved		_			_			_
0x183C	PTLPE	PTLPE7	PTLPE6	PTLPE5	PTLPE4	PTLPE3	PTLPE2	PTLPE1	PTLPE0
0x183D	PTLSE	PTLSE7	PTLSE6	PTLSE5	PTLSE4	PTLSE3	PTLSE2	PTLSE1	PTLSE0
0x183E	PTLDS	PTLDS7	PTLDS6	PTLDS5	PTLDS4	PTLDS3	PTLDS2	PTLDS1	PTLDS0
0x183F	Reserved	—	—	—	—	—	—	—	—
0x1840	PTAPE	PTAPE7	PTAPE6	PTAPE5	PTAPE4	PTAPE3	PTAPE2	PTAPE1	PTAPE0
0x1841	PTASE	PTASE7	PTASE6	PTASE5	PTASE4	PTASE3	PTASE2	PTASE1	PTASE0
0x1842	PTADS	PTADS7	PTADS6	PTADS5	PTADS4	PTADS3	PTADS2	PTADS1	PTADS0
0x1843	Reserved	—			—	—	—	—	—
0x1844	PTASC	0	0	0	0	PTAIF	PTAACK	PTAIE	PTAMOD
0x1845	PTAPS	PTAPS7	PTAPS6	PTAPS5	PTAPS4	PTAPS3	PTAPS2	PTAPS1	PTAPS0
0x1846	PTAES	PTAES7	PTAES6	PTAES5	PTAES4	PTAES3	PTAES2	PTAES1	PTAES0
0x1847	Reserved	—	_	—	—	—	—	—	—
0x1848	PTBPE	PTBPE7	PTBPE6	PTBPE5	PTBPE4	PTBPE3	PTBPE2	PTBPE1	PTBPE0



Table 4-15. FOPT Register Field Descriptions

Field	Description
5 EPGMOD	 EEPROM Sector Mode — When this bit is 0, each sector is split into two pages (4-byte mode). When this bit is 1, each sector is in a single page (8-byte mode). 0 Half of each EEPROM sector is in Page 0 and the other half is in Page 1. 1 Each sector is in a single page.
1:0 SEC	Security State Code — This 2-bit field determines the security state of the MCU as shown in Table 4-16. When the MCU is secure, the contents of RAM, EEPROM and FLASH memory cannot be accessed by instructions from any unsecured source including the background debug interface. SEC changes to 1:0 after successful backdoor key entry or a successful blank check of FLASH. For more detailed information about security, refer to Section 4.6.9, "Security."

SEC[1:0]	Description		
0:0	secure		
0:1	secure		
1:0	unsecured		
1:1	secure		
SEC changes to 1:0 after successful backdoor key optry			

Table 4-16. Security States¹

SEC changes to 1:0 after successful backdoor key entry or a successful blank check of FLASH.

4.6.11.3 FLASH and EEPROM Configuration Register (FCNFG)



Figure 4-16. FLASH and EEPROM Configuration Register (FCNFG)

Table 4-17. FCNFG Register Field Descriptions

Field	Description
6 EPGSEL	 EEPROM Page Select — This bit selects which EEPROM page is accessed in the memory map. 0 Page 0 is in foreground of memory map. Page 1 is in background and can not be accessed. 1 Page 1 is in foreground of memory map. Page 0 is in background and can not be accessed.
5 KEYACC	 Enable Writing of Access Key — This bit enables writing of the backdoor comparison key. For more detailed information about the backdoor key mechanism, refer to Section 4.6.9, "Security." 0 Writes to 0xFFB0–0xFFB7 are interpreted as the start of a FLASH programming or erase command. 1 Writes to NVBACKKEY (0xFFB0–0xFFB7) are interpreted as comparison key writes.



Chapter 4 Memory

4.6.11.5 FLASH and EEPROM Status Register (FSTAT)



Figure 4-18. FLASH and EEPROM Status Register (FSTAT)

Table 4-21. FSTAT Register Field Description	۱S
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Field	Description
7 FCBEF	 Command Buffer Empty Flag — The FCBEF bit is used to launch commands. It also indicates that the command buffer is empty so that a new command sequence can be executed when performing burst programming. The FCBEF bit is cleared by writing a 1 to it or when a burst program command is transferred to the array for programming. Only burst program commands can be buffered. 0 Command buffer is full (not ready for additional commands). 1 A new burst program command can be written to the command buffer.
6 FCCF	 Command Complete Flag — FCCF is set automatically when the command buffer is empty and no command is being processed. FCCF is cleared automatically when a new command is started (by writing 1 to FCBEF to register a command). Writing to FCCF has no meaning or effect. Command in progress All commands complete
5 FPVIOL	 Protection Violation Flag — FPVIOL is set automatically when a command that attempts to erase or program a location in a protected block (the erroneous command is ignored). FPVIOL is cleared by writing a 1 to FPVIOL. 0 No protection violation. 1 An attempt was made to erase or program a protected location.
4 FACCERR	Access Error Flag — FACCERR is set automatically when the proper command sequence is not obeyed exactly (the erroneous command is ignored), if a program or erase operation is attempted before the FCDIV register has been initialized, or if the MCU enters stop while a command was in progress. For a more detailed discussion of the exact actions that are considered access errors, see Section 4.6.6, "Access Errors." FACCERR is cleared by writing a 1 to FACCERR. Writing a 0 to FACCERR has no meaning or effect. 0 No access error. 1 An access error has occurred.
2 FBLANK	 Verified as All Blank (erased) Flag — FBLANK is set automatically at the conclusion of a blank check command if the entire FLASH or EEPROM array was verified to be erased. FBLANK is cleared by clearing FCBEF to write a new valid command. Writing to FBLANK has no meaning or effect. 0 After a blank check command is completed and FCCF = 1, FBLANK = 0 indicates the FLASH or EEPROM array is not completely erased. 1 After a blank check command is completed and FCCF = 1, FBLANK = 1 indicates the FLASH or EEPROM array is completely erased (all 0xFFF).

4.6.11.6 FLASH and EEPROM Command Register (FCMD)

Only six command codes are recognized in normal user modes, as shown in Table 4-22. All other command codes are illegal and generate an access error. Refer to Section 4.6.3, "Program and Erase



6.5.2.5 Port B Drive Strength Selection Register (PTBDS)



Figure 6-15. Drive Strength Selection for Port B Register (PTBDS)

Table 6-13. PTBDS Register Field Descriptions

Field	Description
7:0 PTBDS[7:0]	 Output Drive Strength Selection for Port B Bits — Each of these control bits selects between low and high output drive for the associated PTB pin. For port B pins that are configured as inputs, these bits have no effect. 0 Low output drive strength selected for port B bit n. 1 High output drive strength selected for port B bit n.

6.5.2.6 Port B Interrupt Status and Control Register (PTBSC)

	7	6	5	4	3	2	1	0
R	0	0	0	0	PTBIF	0	DTDIE	
W						PTBACK	FIDIC	FIDINIOD
Reset:	0	0	0	0	0	0	0	0
		= Unimplemer	ited or Reserve	ed				

Figure 6-16. Port B Interrupt Status and Control Register (PTBSC)

Table 6-14. PTBSC Register Field Descriptions

Field	Description
3 PTBIF	 Port B Interrupt Flag — PTBIF indicates when a Port B interrupt is detected. Writes have no effect on PTBIF. 0 No Port B interrupt detected. 1 Port B interrupt detected.
2 PTBACK	Port B Interrupt Acknowledge — Writing a 1 to PTBACK is part of the flag clearing mechanism. PTBACK always reads as 0.
1 PTBIE	 Port B Interrupt Enable — PTBIE determines whether a port B interrupt is requested. 0 Port B interrupt request not enabled. 1 Port B interrupt request enabled.
0 PTBMOD	 Port B Detection Mode — PTBMOD (along with the PTBES bits) controls the detection mode of the port B interrupt pins. 0 Port B pins detect edges only. 1 Port B pins detect both edges and levels.



Field	Description
1 OSCINIT	OSC Initialization — If the external reference clock is selected by ERCLKEN or by the MCG being in FEE, FBE, PEE, PBE, or BLPE mode, and if EREFS is set, then this bit is set after the initialization cycles of the external oscillator clock have completed. This bit is only cleared when either EREFS is cleared or when the MCG is in either FEI, FBI, or BLPI mode and ERCLKEN is cleared.
0 FTRIM	MCG Fine Trim — Controls the smallest adjustment of the internal reference clock frequency. Setting FTRIM will increase the period and clearing FTRIM will decrease the period by the smallest amount possible. If an FTRIM value stored in nonvolatile memory is to be used, it's the user's responsibility to copy that value from the popylatile memory location to this register's FTRIM bit

Table 8-6. MCG Status and Control Register Field Descriptions (continued)

8.3.5 MCG Control Register 3 (MCGC3)



Figure 8-7. MCG Control Register 3 (MCGC3)

Table 8-7. MCG Control Register 3 Field Descriptions

Field	Description
7 LOLIE	 Loss of Lock Interrupt Enable — Determines if an interrupt request is made following a loss of lock indication. The LOLIE bit only has an effect when LOLS is set. 0 No request on loss of lock. 1 Generate an interrupt request on loss of lock.
6 PLLS	 PLL Select — Controls whether the PLL or FLL is selected. If the PLLS bit is clear, the PLL is disabled in all modes. If the PLLS is set, the FLL is disabled in all modes. 1 PLL is selected 0 FLL is selected
5 CME	 Clock Monitor Enable — Determines if a reset request is made following a loss of external clock indication. The CME bit should only be set to a logic 1 when either the MCG is in an operational mode that uses the external clock (FEE, FBE, PEE, PBE, or BLPE) or the external reference is enabled (ERCLKEN=1 in the MCGC2 register). Whenever the CME bit is set to a logic 1, the value of the RANGE bit in the MCGC2 register should not be changed. O Clock monitor is disabled. 1 Generate a reset request on loss of external clock.



Field	Description
4 DIV32	 Divide-by-32 Enable — Controls an additional divide-by-32 factor to the external reference clock for the FLL when RANGE bit is set. When the RANGE bit is 0, this bit has no effect. Writes to this bit are ignored if PLLS bit is set. 0 Divide-by-32 is disabled. 1 Divide-by-32 is enabled when RANGE=1.
3:0 VDIV	VCO Divider — Selects the amount to divide down the VCO output of PLL. The VDIV bits establish the multiplication factor (M) applied to the reference clock frequency. 0000 Encoding 0 — Reserved. 0001 Encoding 1 — Multiply by 4. 0010 Encoding 2 — Multiply by 8. 0011 Encoding 3 — Multiply by 12. 0100 Encoding 4 — Multiply by 16. 0101 Encoding 5 — Multiply by 20. 0110 Encoding 6 — Multiply by 24. 0111 Encoding 7 — Multiply by 28. 1000 Encoding 8 — Multiply by 32. 1001 Encoding 9 — Multiply by 36. 1010 Encoding 10 — Multiply by 40. 1011 Encoding 11 — Reserved (default to M=40). 11xx Encoding 12-15 — Reserved (default to M=40).

Table 8-7. MCG Control Register 3 Field Descriptions (continued)



Chapter 8 Multi-Purpose Clock Generator (S08MCGV2)

8.4 Functional Description

8.4.1 Operational Modes



Figure 8-9. Clock Switching Modes



8.4.3 Bus Frequency Divider

The BDIV bits can be changed at anytime and the actual switch to the new frequency will occur immediately.

8.4.4 Low Power Bit Usage

The low power bit (LP) is provided to allow the FLL or PLL to be disabled and thus conserve power when these systems are not being used. The DRS bit can not be written while LP bit is 1. However, in some applications it may be desirable to enable the FLL or PLL and allow it to lock for maximum accuracy before switching to an engaged mode. Do this by writing the LP bit to 0.

8.4.5 Internal Reference Clock

When IRCLKEN is set the internal reference clock signal will be presented as MCGIRCLK, which can be used as an additional clock source. The MCGIRCLK frequency can be re-targeted by trimming the period of the internal reference clock. This can be done by writing a new value to the TRIM bits in the MCGTRM register. Writing a larger value will decrease the MCGIRCLK frequency, and writing a smaller value to the MCGTRM register will increase the MCGIRCLK frequency. The TRIM bits will effect the MCGOUT frequency if the MCG is in FLL engaged internal (FEI), FLL bypassed internal (FBI), or bypassed low power internal (BLPI) mode. The TRIM and FTRIM value is initialized by POR but is not affected by other resets.

Until MCGIRCLK is trimmed, programming low reference divider (RDIV) factors may result in MCGOUT frequencies that exceed the maximum chip-level frequency and violate the chip-level clock timing specifications (see the Device Overview chapter).

If IREFSTEN and IRCLKEN bits are both set, the internal reference clock will keep running during stop mode in order to provide a fast recovery upon exiting stop.

8.4.6 External Reference Clock

The MCG module can support an external reference clock with frequencies between 31.25 kHz to 40 MHz in all modes. When ERCLKEN is set, the external reference clock signal will be presented as MCGERCLK, which can be used as an additional clock source. When IREFS = 1, the external reference clock will not be used by the FLL or PLL and will only be used as MCGERCLK. In these modes, the frequency can be equal to the maximum frequency the chip-level timing specifications will support (see the Device Overview chapter).

If EREFSTEN and ERCLKEN bits are both set or the MCG is in FEE, FBE, PEE, PBE or BLPE mode, the external reference clock will keep running during stop mode in order to provide a fast recovery upon exiting stop.

If CME bit is written to 1, the clock monitor is enabled. If the external reference falls below a certain frequency (f_{loc_high} or f_{loc_low} depending on the RANGE bit in the MCGC2), the MCU will reset. The LOC bit in the System Reset Status (SRS) register will be set to indicate the error.



Chapter 8 Multi-Purpose Clock Generator (S08MCGV2)



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Chapter 10 Analog-to-Digital Converter (S08ADC12V1)
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If the MODE bits are changed, any data in ADCRH becomes invalid.



10.3.4 Data Result Low Register (ADCRL)

ADCRL contains the lower eight bits of the result of a 12-bit or 10-bit conversion, and all eight bits of an 8-bit conversion. This register is updated each time a conversion completes except when automatic compare is enabled and the compare condition is not met. In 12-bit and 10-bit mode, reading ADCRH prevents the ADC from transferring subsequent conversion results into the result registers until ADCRL is read. If ADCRL is not read until the after next conversion is completed, the intermediate conversion results are lost. In 8-bit mode, there is no interlocking with ADCRH. If the MODE bits are changed, any data in ADCRL becomes invalid.



Figure 10-6. Data Result Low Register (ADCRL

10.3.5 Compare Value High Register (ADCCVH)

In 12-bit mode, the ADCCVH register holds the upper four bits of the 12-bit compare value. When the compare function is enabled, these bits are compared to the upper four bits of the result following a conversion in 12-bit mode.



Figure 10-7. Compare Value High Register (ADCCVH)



Chapter 11 Inter-Integrated Circuit (S08IICV2)



Figure 11-1. MC9S08DZ128 Block Diagram with IIC Highlighted



Arbitration is lost in the following circumstances:

- SDA sampled as a low when the master drives a high during an address or data transmit cycle.
- SDA sampled as a low when the master drives a high during the acknowledge bit of a data receive cycle.
- A start cycle is attempted when the bus is busy.
- A repeated start cycle is requested in slave mode.
- A stop condition is detected when the master did not request it.

This bit must be cleared by software writing a 1 to it.



Field	Description
1 OVRIF	Overrun Interrupt Flag — This flag is set when a data overrun condition occurs. If not masked, an error interrupt is pending while this flag is set. 0 No data overrun condition 1 A data overrun detected
0 RXF ²	Receive Buffer Full Flag — RXF is set by the MSCAN when a new message is shifted in the receiver FIFO. This flag indicates whether the shifted buffer is loaded with a correctly received message (matching identifier, matching cyclic redundancy code (CRC) and no other errors detected). After the CPU has read that message from the RxFG buffer in the receiver FIFO, the RXF flag must be cleared to release the buffer. A set RXF flag prohibits the shifting of the next FIFO entry into the foreground buffer (RxFG). If not masked, a receive interrupt is pending while this flag is set. 0 No new message available within the RxFG 1 The receiver FIFO is not empty. A new message is available in the RxFG

Table 12-9. CANRFLG Register Field Descriptions (continued)

¹ Redundant Information for the most critical CAN bus status which is "bus-off". This only occurs if the Tx error counter exceeds a number of 255 errors. Bus-off affects the receiver state. As soon as the transmitter leaves its bus-off state the receiver state skips to RxOK too. Refer also to TSTAT[1:0] coding in this register.

² To ensure data integrity, do not read the receive buffer registers while the RXF flag is cleared. For MCUs with dual CPUs, reading the receive buffer registers while the RXF flag is cleared may result in a CPU fault condition.

12.3.5 MSCAN Receiver Interrupt Enable Register (CANRIER)

This register contains the interrupt enable bits for the interrupt flags described in the CANRFLG register.

_	7	6	5	4	3	2	1	0
R W	WUPIE	CSCIE	RSTATE1	RSTATE0	TSTATE1	TSTATE0	OVRIE	RXFIE
Reset:	0	0	0	0	0	0	0	0

Figure 12-9. MSCAN Receiver Interrupt Enable Register (CANRIER)

NOTE

The CANRIER register is held in the reset state when the initialization mode is active (INITRQ=1 and INITAK=1). This register is writable when not in initialization mode (INITRQ=0 and INITAK=0).

The RSTATE[1:0], TSTATE[1:0] bits are not affected by initialization mode.

Read: Anytime Write: Anytime when not in initialization mode



Chapter 12 Freescale's Controller Area Network (S08MSCANV1)



Figure 12-28. Identifier Register 3 (IDR3) — Extended Identifier Mapping

Table 12-28. IDR3 Register Field Descriptions — Extended

Field	Description
7:1 ID[6:0]	Extended Format Identifier — The identifiers consist of 29 bits (ID[28:0]) for the extended format. ID28 is the most significant bit and is transmitted first on the CAN bus during the arbithation procedure. The priority of an identifier is defined to be highest for the smallest binary number.
0 RTR	 Remote Transmission Request — This flag reflects the status of the remote transmission request bit in the CAN frame. In the case of a receive buffer, it indicates the status of the received frame and supports the transmission of an answering frame in software. In the case of a transmit buffer, this flag defines the setting of the RTR bit to be sent. 0 Data frame 1 Remote frame

12.4.2 IDR0–IDR3 for Standard Identifier Mapping



Figure 12-29. Identifier Register 0 — Standard Mapping

Table 12-29.	. IDR0 Register Field	Descriptions —	Standard
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Field	Description
7:0 ID[10:3]	Standard Format Identifier — The identifiers consist of 11 bits (ID[10:0]) for the standard format. ID10 is the most significant bit and is transmitted first on the CAN bus during the arbitration procedure. The priority of an identifier is defined to be highest for the smallest binary number. See also ID bits in Table 12-30.

	7	6	5	4	3	2	1	0
R	ID2	ID1	ID0	RTR	IDE ⁽¹⁾			
Reset:	x	x	х	х	х	x	x	x

= Unused; always read 'x'

Figure 12-30. Identifier Register 1 — Standard Mapping

¹ IDE is 0.





Figure 12-33. Data Segment Registers (DSR0–DSR7) — Extended Identifier Mapping

Table 12-31. DSR0–DSR7 Register Field Descriptions

Field	Description
7:0 DB[7:0]	Data bits 7:0

12.4.4 Data Length Register (DLR)

This register keeps the data length field of the CAN frame.



= Unused; always read "x"



Table 12-32. DLR Register Field Descriptions

Field	Description
3:0 DLC[3:0]	Data Length Code Bits — The data length code contains the number of bytes (data byte count) of the respective message. During the transmission of a remote frame, the data length code is transmitted as programmed while the number of transmitted data bytes is always 0. The data byte count ranges from 0 to 8 for a data frame. Table 12-33 shows the effect of setting the DLC bits



Chapter 13 Serial Peripheral Interface (S08SPIV3)

13.5 Functional Description

An SPI transfer is initiated by checking for the SPI transmit buffer empty flag (SPTEF = 1) and then writing a byte of data to the SPI data register (SPIxD) in the master SPI device. When the SPI shift register is available, this byte of data is moved from the transmit data buffer to the shifter, SPTEF is set to indicate there is room in the buffer to queue another transmit character if desired, and the SPI serial transfer starts.

During the SPI transfer, data is sampled (read) on the MISO pin at one SPSCK edge and shifted, changing the bit value on the MOSI pin, one-half SPSCK cycle later. After eight SPSCK cycles, the data that was in the shift register of the master has been shifted out the MOSI pin to the slave while eight bits of data were shifted in the MISO pin into the master's shift register. At the end of this transfer, the received data byte is moved from the shifter into the receive data buffer and SPRF is set to indicate the data can be read by reading SPIxD. If another byte of data is waiting in the transmit buffer at the end of a transfer, it is moved into the shifter, SPTEF is set, and a new transfer is started.

Normally, SPI data is transferred most significant bit (MSB) first. If the least significant bit first enable (LSBFE) bit is set, SPI data is shifted LSB first.

When the SPI is configured as a slave, its \overline{SS} pin must be driven low before a transfer starts and \overline{SS} must stay low throughout the transfer. If a clock format where CPHA = 0 is selected, \overline{SS} must be driven to a logic 1 between successive transfers. If CPHA = 1, \overline{SS} may remain low between successive transfers. See Section 13.5.1, "SPI Clock Formats" for more details.

Because the transmitter and receiver are double buffered, a second byte, in addition to the byte currently being shifted out, can be queued into the transmit data buffer, and a previously received character can be in the receive data buffer while a new character is being shifted in. The SPTEF flag indicates when the transmit buffer has room for a new character. The SPRF flag indicates when a received character is available in the receive data buffer. The received character must be read out of the receive buffer (read SPIxD) before the next transfer is finished or a receive overrun error results.

In the case of a receive overrun, the new data is lost because the receive buffer still held the previous character and was not ready to accept the new data. There is no indication for such an overrun condition so the application system designer must ensure that previous data has been read from the receive buffer before a new transfer is initiated.

13.5.1 SPI Clock Formats

To accommodate a wide variety of synchronous serial peripherals from different manufacturers, the SPI system has a clock polarity (CPOL) bit and a clock phase (CPHA) control bit to select one of four clock formats for data transfers. CPOL selectively inserts an inverter in series with the clock. CPHA chooses between two different clock phase relationships between the clock and data.

Figure 13-10 shows the clock formats when CPHA = 1. At the top of the figure, the eight bit times are shown for reference with bit 1 starting at the first SPSCK edge and bit 8 ending one-half SPSCK cycle after the sixteenth SPSCK edge. The MSB first and LSB first lines show the order of SPI data bits depending on the setting in LSBFE. Both variations of SPSCK polarity are shown, but only one of these waveforms applies for a specific transfer, depending on the value in CPOL. The SAMPLE IN waveform applies to the MOSI input of a slave or the MISO input of a master. The MOSI waveform applies to the MOSI output



Table 14-6. SCIxS1 Field Descriptions (continued)

Field	Description
1 FE	 Framing Error Flag — FE is set at the same time as RDRF when the receiver detects a logic 0 where the stop bit was expected. This suggests the receiver was not properly aligned to a character frame. To clear FE, read SCIxS1 with FE = 1 and then read the SCI data register (SCIxD). 0 No framing error detected. This does not guarantee the framing is correct. 1 Framing error.
0 PF	 Parity Error Flag — PF is set at the same time as RDRF when parity is enabled (PE = 1) and the parity bit in the received character does not agree with the expected parity value. To clear PF, read SCIxS1 and then read the SCI data register (SCIxD). 0 No parity error. 1 Parity error.

14.2.5 SCI Status Register 2 (SCIxS2)

This register has one read-only status flag.



Figure 14-9. SCI Status Register 2 (SCIxS2)

Table 14-7. SCIxS2 Field Descriptions

Field	Description
7 LBKDIF	 LIN Break Detect Interrupt Flag — LBKDIF is set when the LIN break detect circuitry is enabled and a LIN break character is detected. LBKDIF is cleared by writing a "1" to it. 0 No LIN break character has been detected. 1 LIN break character has been detected.
6 RXEDGIF	 RxD Pin Active Edge Interrupt Flag — RXEDGIF is set when an active edge (falling if RXINV = 0, rising if RXINV=1) on the RxD pin occurs. RXEDGIF is cleared by writing a "1" to it. 0 No active edge on the receive pin has occurred. 1 An active edge on the receive pin has occurred.
4 RXINV ¹	 Receive Data Inversion — Setting this bit reverses the polarity of the received data input. 0 Receive data not inverted 1 Receive data inverted
3 RWUID	 Receive Wake Up Idle Detect— RWUID controls whether the idle character that wakes up the receiver sets the IDLE bit. 0 During receive standby state (RWU = 1), the IDLE bit does not get set upon detection of an idle character. 1 During receive standby state (RWU = 1), the IDLE bit gets set upon detection of an idle character.
2 BRK13	 Break Character Generation Length — BRK13 is used to select a longer transmitted break character length. Detection of a framing error is not affected by the state of this bit. 0 Break character is transmitted with length of 10 bit times (11 if M = 1) 1 Break character is transmitted with length of 13 bit times (14 if M = 1)





A.12 AC Characteristics

This section describes ac timing characteristics for each peripheral system.

A.12.1 Control Timing

Table A-13. Control Timing

Num	С	Rating	Symbol	Min	Typical ¹	Max	Unit
1	D	Bus frequency (t _{cyc} = 1/f _{Bus})	f _{Bus}	dc	—	20	MHz
2	D	Internal low-power oscillator period	t _{LPO}	800		1500	μs
3	D	External reset pulse width ²	t _{extrst}	100			ns
4	D	Reset low drive ³	t _{rstdrv}	34 x t _{cyc}		_	ns
5	D	Active background debug mode latch setup time	t _{MSSU}	500		_	ns
6	D	Active background debug mode latch hold time	t _{MSH}	100			ns
7	D	IRQ/PIAx/ PIBx/PIDx/PIJx pulse width Asynchronous path ² Synchronous path ³	t _{ILIH} , t _{IHIL}	100 1.5 t _{cyc}	_	_	ns
		Port rise and fall time $(load = 50 \text{ pF})^4$					
8	С	Slew rate control disabled	t _{Rise} , t _{Fall}	—	3		ns
		Slew rate control enabled		—	30		

¹ Typical data was characterized at 5.0 V, 25°C unless otherwise stated.

² This is the shortest pulse that is guaranteed to be recognized as a RESET pin or pin interrupt request. Shorter pulses are not guaranteed to override reset requests from internal sources.

1. Based on the average of several hundred units from a typical characterization lot.





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